
	<h2 style="color: #E67E22;">IDT23S09-1HPGI</h2>	
	Manufacturer Part Number:	IDT23S09-1HPGI
	Manufacturer/Brand:	IDT (Integrated Device Technology)
	Part of Description:	IC CLK BUFF ZD HI DRV 16-TSSOP
Datasheets:	 IDT23S09-1HPGI.pdf	
RoHs Status:	Contains lead / RoHS non-compliant	
Stock Condition:	New original, Stock Available.	
Ship From:	Hong Kong	
Shipment Way:	DHL/Fedex/TNT/UPS/EMS	
<p>Image may be representation. See specs for product details.</p>		









Specifications

Part Number	IDT23S09-1HPGI
Manufacturer	IDT (Integrated Device Technology)
Description	IC CLK BUFF ZD HI DRV 16-TSSOP
Category	Integrated Circuits (ICs) > Clock/Timing - Clock
Part Status	Require For Quote & Check Stock
Series	-
Operating Temperature	-40°C ~ 85°C
Mounting Type	Surface Mount
Type	Zero Delay Buffer
Frequency - Max	133MHz
Package / Case	16-TSSOP (0.173", 4.40mm Width)
Supplier Device Package	16-TSSOP
Number of Circuits	1
Voltage - Supply	3 V ~ 3.6 V
Output	CMOS, LVTTTL
Input	LVTTTL
PLL	Yes with Bypass
Ratio - Input:Output	1:9
Differential - Input:Output	No/No
Divider/Multiplier	No/No
Packaging	Tube

IDT23S09-1HPGI is New Original in Stock, Search IDT23S09-1HPGI Datasheets, PDF, Inventory at Y-IC.com Online, Order IDT23S09-1HPGI IDT (Integrated Device Technology) with warrantied and confidence. RFQ IDT23S09-1HPGI : Info@Y-IC.com

You May Be Also Be interested

In:

 <p>IDT23S09-1HDCI IDT (Integrated Device Technology) IC CLK BUFF ZD HI DRV 16-SOIC</p>	 <p>IDT23S09E-1DC IDT (Integrated Device Technology) IC CLK BUFFER ZD STD DRV 16-SOIC</p>	 <p>IDT23S09-1HDC8 IDT (Integrated Device Technology) IC CLK BUFF ZD HI DRV 16-SOIC</p>	 <p>IDT23S09E-1DC8 IDT (Integrated Device Technology) IC CLK BUFFER ZD STD DRV 16-SOIC</p>
 <p>IDT23S09E-1DCG8 IDT (Integrated Device Technology) IC CLK BUFFER ZD STD DRV 16-SOIC</p>	 <p>IDT23S09-1HPG IDT (Integrated Device Technology) IC CLK BUFF ZD HI DRV 16-TSSOP</p>	 <p>IDT23S09-1HDCI8 IDT (Integrated Device Technology) IC CLK BUFF ZD HI DRV 16-SOIC</p>	 <p>IDT23S09-1HPG8 IDT (Integrated Device Technology) IC CLK BUFF ZD HI DRV 16-TSSOP</p>

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|-------------------------|-----------------------|---------------------------|-----------------------|-----------------------|
| ⚙️ 0402YA9R0DAT2A | ➡️ 06033A4R3JAT2A | ➡️ 12101A222J4T2A | D AD8601DRT-REEL7 | ➡️ AM14N25-280D |
| ⚡️ AQH3223AZ | ⚙️ BD7785RFS-E2 | D C1608X8R1E683K080AA | ➡️ CC1206GRNP09BN150 | ➡️ CD4007UBPWRG4 |
| ⚙️ CGJ5L2X7R2A154K160AA | ⚡️ D1772-BL | ⚙️ DDZ36S-7 | ➡️ DTA114WKHRAT146 | ➡️ EXQ125-48S3V3-ZR |
| D F1206A1R25FWTR | ⚙️ FDS5351-NL | ⚡️ GCM1885C1H392JA16J | ⚙️ GQM1555C2D9R4CB01D | ➡️ GRM1555C1H4R2BZ01D |
| ➡️ ICS97U877AHT | ➡️ IRLR120TRPBF | ⚙️ LM4850LDX | ⚡️ LMSP43QC-B31 | ➡️ LP5907MF-3.0 |
| ➡️ LTC4230CGN#PBF | ➡️ MAX3074EEPA | D MAX667CSA+T | ⚙️ MB40C348PFV-G-BND | ⚡️ MBR12040 |
| ⚙️ MDD310-16N1 | D MIC4575-3.3BT | ➡️ OPA2171AIDR | ➡️ R2051K01-E2 | ➡️ S-81211SG-QA-T1 |
| ⚡️ S71PL032J04BAW0B0 | ⚙️ SC667005VMC12 | ➡️ SMAJ90A-E3/61 | ➡️ SN75ALS181NSR | ➡️ SP8M24FRA |
| ⚙️ SPP06N80C3 | ⚡️ SSC53LHE3/57T | ⚙️ TC58NVG1S3HBAI4 | D TCM3105N | ➡️ TLZ15C-GS08 |
| ➡️ TMP86CM29BU-5RK0 | ⚙️ UHE-12/2500-Q48N-C | ⚡️ UPD44325362BF5-E40-FQ1 | ⚙️ VNH3SP30-E | ➡️ Z8700116FSC |

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